	Туре	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	44	test\$4 same ((integrated near2 circuit) or IC or chips or device or	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/08/18 11:04
2	BRS	L2	19851	deposit\$4 near4 oxide near8 (substrate or substrates or wafer or wafers)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/08/18 11:05
3	BRS	L3	386	2 same lithograph\$4	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/08/18 11:05
4	BRS	L4	43751	(sputter\$4 or CVD) near4 (metal or aluminum or electrode or conductive)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/08/18 11:07
5	BRS	L5	105	3 and 4	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/08/18 11:08

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	Туре	L #	Hits	Search Text	DBs	Tim	Stamp
6	BRS	L6	13	5 and probe	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/ 11:09	08/18

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	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L3	1476	lithograph\$4 same (deposit\$4 near4 oxide)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/08/18 13:54
2	BRS	L4	181	3 same sputter\$4	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/08/18 14:07
3	BRS	L5	10	4 and probe	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/08/18 14:08
4	BRS	L6	34	!	USPAT; US-PGP UB; ÈPO; JPO; DÉRWEN T; IBM_TD B	2003/08/18 14:19
5	BRS	L 7	792	micro adj3 tip	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/08/18 14:37

(sputter \$4) (Enemy (metal or Alor aluminum "")

	Туре	L #	Hits	Search Text	DBs	Time Stamp
6	BRS	L8	775	migro adia probe	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/08/18 14:38

LI same L2